MATERIALS & SPECIFICATIONS

HOUSING:
ALUMINUM 6061-T6, NICKEL PLATE PER AMS-C-26074

INSULATOR:
LIQUID CRYSTAL POLYMER (LCP) PER ASTM D5138

CONTACTS:
COPPER ALLOY PER MIL-DTL-32139, GOLD PLATED PER ASTM B488, (HARD GOLD) TYPE II CODE C, CLASS 1.27

TERMINATION:
SOLDER COATED WITH SN63A PER J-STD-006

CURRENT RATING:
1 AMP MAX PER MIL-DTL-32139

CONTACT RESISTANCE:
71 MILLIOHM MAX (71mV DROP MAX) @ 1.0 AMPS PER MIL-DTL-32139

PERFORMANCE:
PRODUCT FAMILY TESTED TO AND PASSED THE PERFORMANCE SPECIFICATIONS OF TABLE VIII OF MIL-DTL-32139

SUGGESTED HOLE PATTERN

SOLDER COATED

CONTACT RESISTANCE:
71 MILLIOHM MAX (71mV DROP MAX) @ 1.0 AMPS PER MIL-DTL-32139

TERMINATION:
SOLDER COATED WITH SN63A PER J-STD-006

CURRENT RATING:
1 AMP MAX PER MIL-DTL-32139

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SUGGESTED HOLE PATTERN

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CURRENT RATING:
1 AMP MAX PER MIL-DTL-32139

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71 MILLIOHM MAX (71mV DROP MAX) @ 1.0 AMPS PER MIL-DTL-32139

PERFORMANCE:
PRODUCT FAMILY TESTED TO AND PASSED THE PERFORMANCE SPECIFICATIONS OF TABLE VIII OF MIL-DTL-32139

TAIL DIMENSIONS APPLY AT PLANE A

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